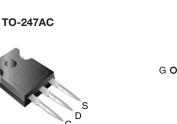
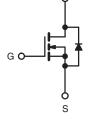


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Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	500				
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.28			
Q _g (Max.) (nC)	130				
Q _{gs} (nC)	33				
Q _{gd} (nC)	59				
Configuration	Single				





N-Channel MOSFET

FEATURES

· SuperFast Body Diode Eliminates the Need For External Diodes in ZVS Applications



RoHS

COMPLIANT

- Low Gate Charge Results in Simple Drive Requirement
- Enhanced dV/dt Capabilities Offer Improved Ruggedness
- Higher Gate Voltage Threshold Offers Improved Noise Immunity
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Zero Voltage Switching SMPS
- Telecom and Server Power Supplies
- Uninterruptible Power Supply
- Motor Control applications

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	IRFP17N50LPbF
	SiHFP17N50L-E3
SnPb	IRFP17N50L
	SiHEP17N501

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	500	v	
Gate-Source Voltage			V _{GS}	± 30	v	
Continuous Drain Current	V _{GS} at 10 V	T _C = 25 °C	- I _D	16		
		T _C = 100 °C		11	А	
Pulsed Drain Current ^a			I _{DM}	64		
Linear Derating Factor				1.8	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	390	mJ	
Repetitive Avalanche Current ^a			I _{AR}	16	А	
Repetitive Avalanche Energy ^a			E _{AR}	22	mJ	
Maximum Power Dissipation	T _C = 25 °C		P _D	220	W	
Peak Diode Recovery dV/dt ^c			dV/dt	13	V/ns	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150			
Soldering Recommendations (Peak Temperature)	for 10 s			300 ^d	- °C	
Mounting Torque	6-32 or M3 screw			10	lbf · in	
				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Starting T_J = 25 °C, L = 3.0 mH, R_g = 25 Ω , I_{AS} = 16 A (see fig. 12). c. I_{SD} ≤ 16 A, dI/dt ≤ 347 A/µs, V_{DD} ≤ V_{DS}, T_J ≤ 150 °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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PARAMETER	SYMBOL	TYP		MAX.			UNIT		
					UNIT				
Maximum Junction-to-Ambient	R _{thJA}	- 62				00.00			
Case-to-Sink, Flat, Greased Surface Maximum Junction-to-Case (Drain)	R _{thCS}	0.50 -				°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}	- 0.56							
SPECIFICATIONS (T _J = 25 °C, u	nless otherw	ise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS			MIN.	TYP.	MAX.	UNI	
Static									
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 25	i0 μA	500	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$		e to 25 °C, I _D		-	0.60	-	V/°	
Gate-Source Threshold Voltage	V _{GS(th)}		= V _{GS} , I _D = 25		3.0	-	5.0	V	
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30 V$		-	_	± 100	nA	
	'G88	$V_{GS} = \pm 30 V$ $V_{DS} = 500 V, V_{GS} = 0 V$			-	-	50	μA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ $V_{DS} = 400 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$			-	_	2.0	m/	
Drain-Source On-State Resistance	P				-	0.28	0.32	Ω	
Forward Transconductance	R _{DS(on)}	$\begin{array}{c c c c c c c c c c c c c c c c c c c $		11	-	-	S		
	9 _{fs}	VDS -	= 50 v, i <u>D</u> = 9	.5 A-	11	_		3	
Dynamic	<u> </u>	[-	0760	-	r	
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1.0 MHz, see fig. 5			2760	-			
Output Capacitance	C _{oss}			-	325	-			
Reverse Transfer Capacitance	C _{rss}	1 = 1				37	-	pF	
Output Capacitance	C _{oss}			= 1.0 V , f = 1.0 MHz		3690	-		
			$V_{DS} = 400 \text{ V}$, f = 1.0 MHz	-	84	-			
Effective Output Capacitance	C _{oss} eff.	$V_{GS} = 0 V$		-	159	-			
Effective Output Capacitance (Energy Related)	C_{oss} eff. (ER)		V _{DS} = 0 V to 400 V		-	120	-		
Internal Gate Resistance	R _g	f = 1	MHz, open o	drain	-	1.4	-	Ω	
Total Gate Charge	Qg		I _D = 16 A, V _{DS} = 40 see fig. 7 and 15	V 400 V	-	-	130	nC	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$		50	-	-	33		
Gate-Drain Charge	Q _{gd}		see lig. 7 and 15		-	-	59	1	
Turn-On Delay Time	t _{d(on)}				-	21	-		
Rise Time	t _r	$V_{DD} = 250 \text{ V}, \text{ I}_{D} = 16 \text{ A}$		-	51	-			
Turn-Off Delay Time	t _{d(off)}	$R_{G} = 7.5 \Omega, V_{GS} = 10 V$ see fig. 14a and 14b ^b		-	50	-	- ns		
Fall Time	t _f			-	28	-			
Drain-Source Body Diode Characteristic	s	L							
Continuous Source-Drain Diode Current	IS	MOSFET symbol showing the integral reverse p - n junction diode			-	-	16		
Pulsed Diode Forward Current ^a	I _{SM}			-	-	64	A		
Body Diode Voltage	V _{SD}	T _J = 25 °C	C, I _S = 16 A, V	$V_{\rm GS} = 0 \ \rm V^b$	-	-	1.5	V	
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C			-	170	250		
		T _J = 125 °C		= 16 A,	-	220	330	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	T _J = 25 °C	dl/dt =	100 A/µs ^b	_	470	710		
		T _J = 125 °C			-	810	1210	μC	
Reverse Recovery Current	I _{RRM}	13 = 120 0	Т _Ј = 25 °С		-	7.3	11	<u> </u>	
Forward Turn-On Time	rRRM t _{on}			negligible (turn-				<u> </u>	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
b. Pulse width ≤ 300 µs; duty cycle ≤ 2 %.
c. C_{OSS} eff. is a fixed capacitance that gives the same charging time as C_{OSS} while V_{DS} is rising fom 0 % to 80 % V_{DS}. C_{OSS} eff. (ER) is a fixed capacitance that stores the same energy as C_{OSS} while V_{DS} is rising fom 0 % to 80 % V_{DS}.

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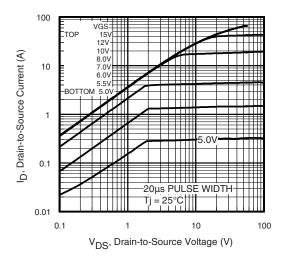


Fig. 1 - Typical Output Characteristics

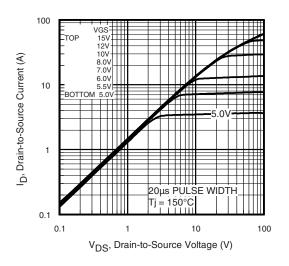


Fig. 2 - Typical Output Characteristics

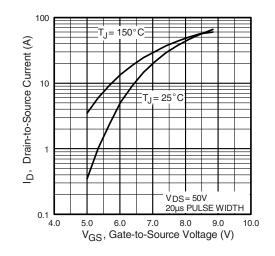


Fig. 3 - Typical Transfer Characteristics

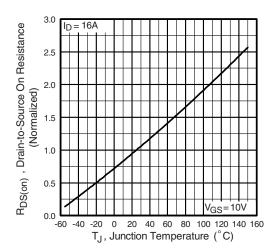


Fig. 4 - Normalized On-Resistance vs. Temperature

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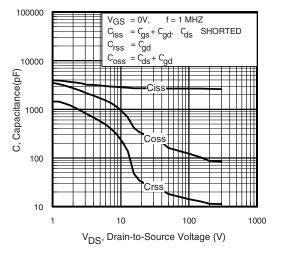


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

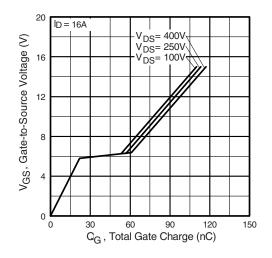


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

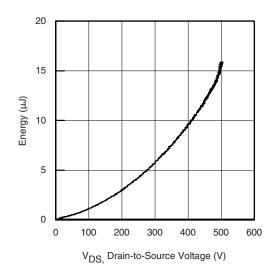


Fig. 6 - Typ. Output Capacitance Stored Energy vs. V_{DS}

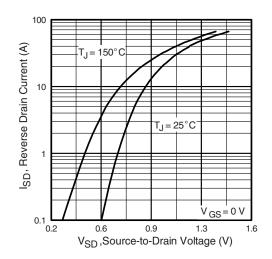


Fig. 8 - Typical Source-Drain Diode Forward Voltage



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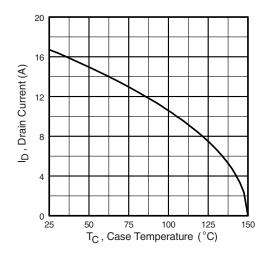


Fig. 9 - Maximum Drain Current vs. Case Temperature

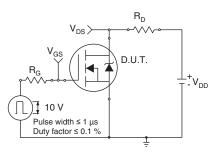


Fig. 10a - Switching Time Test Circuit

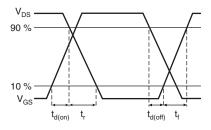


Fig. 10b - Switching Time Waveforms

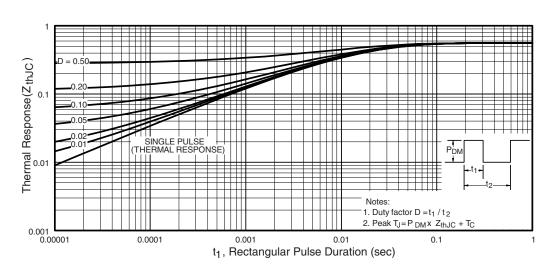


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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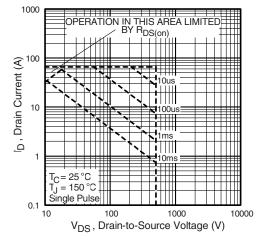


Fig. 12 - Maximum Safe Operating Area

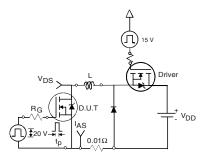


Fig. 14a - Unclamped Inductive Test Circuit

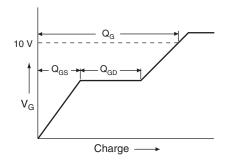


Fig. 15a - Basic Gate Charge Waveform

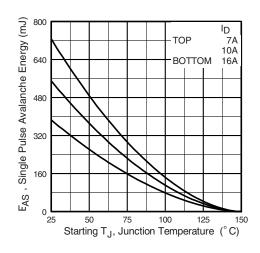


Fig. 13 - Maximum Avalanche Energy vs. Drain Current

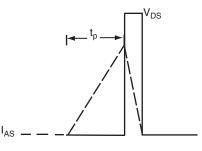
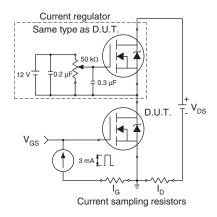


Fig. 14b - Unclamped Inductive Waveforms





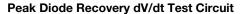
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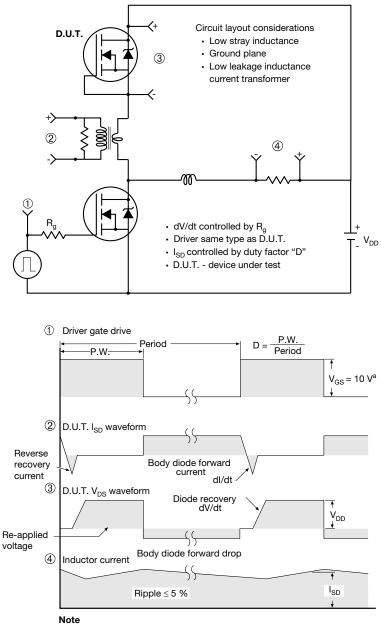
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a. V_{GS} = 5 V for logic level devices

Fig. 16. For N-Channel

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